## **Amendments to the Claims**

This listing of claims will replace all prior versions, and listings, of claims in the application:

## **Listing of Claims:**

Claims 1-16. (Cancelled)

- 17. (Currently Amended) a solid support comprising:
- a. A substrate;
- b. An electrostatic layer comprising a positively charged compound on the substrate; and
- c. A chemically modifying layer on the electrostatic layer making it possible to introduce a functional group capable of covalently binding to a nucleic acid molecule; and
- d. A nucleic acid molecule bonded covalently to the chemically modifying layer.
- 18. (Previously Presented) The solid support according to claim 17, wherein the chemically modifying layer contains a carboxyl group.
- 19. (Previously Presented) The solid support according to claim 17, wherein the electrostatic layer includes an amino group-containing compound that does not covalently bond to the substrate.
- 20. (Previously Presented) The solid support according to claim 17. wherein the electrostatic layer includes an amino group-containing compound by covalently binding to the substrate, and the compound containing an amino group has an amino group at the terminus to which the substrate does not bind.

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- 21. (Previously Presented) The solid support according to claim 19, wherein the amino group-containing compound is polyarylamine.
- 22. (Previously Presented) The solid support according to claim 17, wherein the thermal conductivity of the solid support is 0.1 W/cm.K or higher.

Claims 23-30. (Cancelled)

- 31. (New) The solid support according to claim 17, wherein the nucleic acid molecule is immobilized as a spot
  - 32. (New) The solid support according to claim 17, wherein the thickness of the electrostatic layer is 1 micron to 500 microns.